



Information and Control Global Technical Committee
Japan TC Chapter
Meeting Summary and Minutes

Japan Spring Meetings 2021
 Thursday, April 15, 2021, Begin 2:00 p.m. – End 4:30 p.m. [JST]
 Web Conference

TC Chapter Announcements

Next TC Chapter Meeting

Tuesday, September 28, 2021, 09:30 a.m. -12:00 noon

WEB/SEMI Japan office, Tokyo, Japan

Table 1 Meeting Attendees

Italics indicate virtual participants

Co-Chairs: Takayuki Nishimura (SCREEN Semiconductor Solutions), Mitsuhiro Matsuda (KOKUSAI ELECTRIC)

SEMI Staff: Mami Nakajo

<i>Company</i>	<i>Last</i>	<i>First</i>	<i>Company</i>	<i>Last</i>	<i>First</i>
<i>Tokyo Electron</i>	<i>Nagata</i>	<i>Masaya</i>	<i>Tokyo Electron</i>	<i>Mochizuki</i>	<i>Tadashi</i>
<i>IBM Japan Digital Services</i>	<i>Ohishi</i>	<i>Osamu</i>	<i>Yokogawa Solution Service</i>	<i>Yamaki</i>	<i>Takeo</i>
<i>Yokogawa Solution Service</i>	<i>Nakagawa</i>	<i>Takashi</i>	<i>SCREEN Semiconductor Solutions</i>	<i>Nishimura</i>	<i>Takayuki</i>
<i>PEER Group</i>	<i>Fuchigami</i>	<i>Albert</i>	<i>Hitachi High-Tech</i>	<i>Toyoshima</i>	<i>Yuko</i>
<i>Mitsubishi Electric</i>	<i>Shi</i>	<i>Xiaonan</i>	<i>Zama Consulting</i>	<i>Sakamoto</i>	<i>Mitsune</i>
<i>Tokyo Electron</i>	<i>Murata</i>	<i>Naoko</i>	<i>KOKUSAI ELECTRIC</i>	<i>Matsuda</i>	<i>Mitsuhiro</i>
<i>Hitachi High-Tech</i>	<i>Yamaki</i>	<i>Takuma</i>	<i>DAIFUKU CO, LTD.</i>	<i>Suzuki</i>	<i>Tomoko</i>
<i>Hitachi High-Tech</i>	<i>Oka</i>	<i>Kenji</i>	<i>Vistaideal Consulting</i>	<i>Asakawa</i>	<i>Terry</i>
			<i>SEMI Japan</i>	<i>Nakajo</i>	<i>Mami</i>

Table 2 Leadership Changes

None

Table 3 Committee Structure Changes

None

Table 4 Ballot Results

None

Table 5 Activities Approved by the GCS between meetings of the TC Chapter

None

Table 6 Authorized Activities

#	Type	SC/TF/WG	Details
6770	SNARF	Japan I&C Maintenance Task Force	Line-Item revision to E169-0615 Guide for Equipment Information System Security

Table 7 Authorized Ballots

None

Table 8 SNARF(s) Granted a One-Year Extension

None

Table 9 SNARF(s) Abolished

None

Table 10 Standard(s) to receive Inactive Status

None

Table 11 New Action Items

Item #	Assigned to	Details
20210415_1	Japan I&C Maintenance Task Force	To consider action to SEMI E99-0317, SEMI E99.1-0317

Table 12 Previous Meeting Action Items

Item #	Assigned to	Details
20201204_1	SEMI Japan Staff	To send the minutes of the previous I&C Committee meeting to the cochairs and upload it properly on the website.> Done
20201204_2	SEMI Japan Staff	To tell HQ to change the wording on slide 15 of the Staff Report. Currently, it is taken as an expression that participating in the Task Force Room of Connect@SEMI means becoming a TF member, which is incorrect.> Done
20201404_3	GEM300 Task Force	To consider action to SEMI E171-0916.> On going
20201404_4	Japan I&CC Maintenance Task Force	To prepare SNARF for SEMI E169-0615.> Done

1. Welcome, Reminders, and Introductions

Takayuki Nishimura (SCREEN Semiconductor Solutions) called the meeting to order at 2:00 p.m. The meeting reminders on antitrust issues, intellectual property issues and holding meetings with international attendance were reviewed. Attendees introduced themselves.

Attachment: 01-02_Required Element Nov 2020 Rev1_E+J_r1

2. Technical Committee Award

The following member received Technical Committee Awards.



Takuma Yamaki /Hitachi High-Tech Corporation

3. Review of Previous Meeting Minutes

The TC Chapter reviewed the minutes of the time before the last meeting.

Motion:	Approve the time before the last meeting minutes of the I&C Japan TC Chapter on December 13, 2019
By / 2nd:	Mitsuhiro Matsuda (KOKUSAI ELECTRIC) / Mitch Sakamoto (ZAMA Consulting)
Discussion:	None
Vote:	15 in favor and 0 opposed. Motion Passed.

The TC Chapter reviewed the minutes of the previous meeting.

Motion:	Approve the previous meeting minutes of the I&C Japan TC Chapter on December 4, 2020.
By / 2nd:	Mitsuhiro Matsuda (KOKUSAI ELECTRIC) / Mitch Sakamoto (ZAMA Consulting)
Discussion:	None
Vote:	15 in favor and 0 opposed. Motion Passed.

Attachment: 03-01_20191213_IC_Minutes_Draft_R1.0, 03-02_201204_IC Japan Min_v1.0

4. Liaison Reports

4.1 Information and Control Korea TC Chapter

Mitsuhiro Matsuda (KOKUSAI ELECTRIC) reported for the TC Chapter.

Attachment: 04-01_Liaison report_InC_KR__Apr2021

4.2 Information and Control North America TC Chapter

Albert Fuchigami (*PEER Group*) reported for the TC Chapter.

Attachment: 04-02_NA I&C Liaison Report 2021-April v1

4.3 Information and Control Taiwan TC Chapter

Takayuki Nishimura (SCREEN Semiconductor Solutions) reported for the TC Chapter.

Attachment: 04-03_IC Taiwan Liaison report_20210107_v1

4.4 SEMI Staff Report

Mami Nakajo (SEMI) gave the SEMI Staff Report.

Attachment: 04-04_Staff Report March 2021_v2_Update add

5. Ballot Review

None

6. Subcommittee and Task Force Reports

6.1 GEM300 TF

Masaya Nagata (Tokyo Electron) gave a report based on the materials.

Attachment: 06-01_JA_ICC_GEM300_TF_Report_2021_0415_R0.0

6.2 Japan I&C Maintenance Task Force

Mitsuhiro Matsuda (KOKUSAI ELECTRIC) gave a report based on the materials.

Attachment: 06-02_20210414MaintenanceTFReport

6.3 Sensor Bus Task Force

No report

6.4 Diagnostic Data Acquisition (DDA) Task Force

Mitch Sakamoto (ZAMA Consulting) gave a report based on the materials.

Attachment: 06-04_DD ATF_Japan_Report_20210415

6.5 Fab & Equipment Information Security Task Force

Tadashi Mochizuki (Tokyo Electron) gave a report based on the materials.

Attachment: 06-05_SEMI_JA_ICC_FEIS_TF_Report_20210415-R0.1

6.6 Backend Factory Integration Task Force

No report

7. Old Business

7.1 SNARF Project Period Check

There are no SNARFs to be reviewed.

7.2 5 Years Review Check

7.2.1 SEMI E99-0317, Specification for Carrier ID Reader/Writer and SEMI E99.1-0317 Specification for SECS-I and SECS-II Protocol for Carrier ID Reader/Writer

Japan I&C Maintenance Task Force is assigned to review it.

Action Item: 20210415_1, To consider action to SEMI E99-0317 and SEMI E99.1-0317.

7.2.2 Report recommended action to SEMI E171-0916

GEM 300 Task Force will report in the next TC Chapter meeting.

8. New Business

8.1 Consider JA GEM300 TF TFOF revision based on the latest NA GEM300 TF TFOF



Mitsuhiro Matsuda (KOKUSAI ELECTRIC) introduced the latest NA GEM300 TF TFOF and JA GEM300 TF will consider their TFOF.

8.2 SNARF Submission

8.2.1 Line-Item revision to E169-0615 Guide for Equipment Information System Security

Mitsuhiro Matsuda (KOKUSAI ELECTRIC) addressed the TC chapter on this topic.

Motion:	Approve the SNARF for Line-Item revision to E169-0615 Guide for Equipment Information System Security
By / 2nd:	Mitsuhiro Matsuda (KOKUSAI ELECTRIC) / Masaya Nagata (Tokyo Electron)
Discussion:	None
Vote:	15 in favor and 0 opposed. Motion Passed.

Attachment: 20210405_E169LIRevison_SNARF_Feb2020r2

9. Action Item Review

9.1 Open Action Items

20201404_3	GEM300 Task Force	To consider action to SEMI E171-0916.>On going
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9.2 New Action Items

20210415_1	Japan I&C Maintenance Task Force	To consider action to SEMI E99-0317 and SEMI E99.1-0317
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10. Next Meeting and Adjournment

The next meeting is scheduled for Tuesday, September 28, 2021, Begin 09:30 a.m. – End 12:00 noon [JST]

at SEMI Japan Office, Tokyo, Japan & Official Virtual TC Chapter Meeting. See <http://www.semi.org/standards-events> for the current list of events.

Adjournment: 4:30 p.m.

Respectfully submitted by:

Mami Nakajo
Standards & EHS
SEMI Japan

Phone: 81.3.3222.5949

Email: mnakajo@semi.org

Minutes tentatively approved by:

Takayuki Nishimura (SCREEN Semiconductor Solutions), Co-chair	May 6,2021
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Mitsuhiro Matsuda (KOKUSAI ELECTRIC), Co-chair	April 28, 2021
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Table 13 Index of Available Attachments^{#1}

<i>Title</i>	<i>Title</i>
01-02_Required Element Nov 2020 Rev1_E+J_r1	04-04_Staff Report March 2021_v2_Update add
03-01_20191213_IC_Minutes_Draft_R1.0	20210405_E169LIREvison_SNARF_Feb2020r2
03-02_201204_IC Japan Min_v1.0	06-01_JA_ICC_GEM300_TF_Report_2021_0415_R0.0
04-01_Liaison report_InC_KR_Apr2021	06-02_20210414MaintenanceTFReport
04-02_NA I&C Liaison Report 2021-April v1	06-04_DDATF_Japan_Report_20210415
04-03_IC Taiwan Laison report_20210107_v1	06-05_SEMI_JA_ICC_FEIS_TF_Report_20210415-R0.1

#1 Due to file size and delivery issues, attachments must be downloaded separately. A .zip file containing all attachments for these minutes is available at www.semi.org. For additional information or to obtain individual attachments, please contact [SEMI Staff Name] at the contact information above.